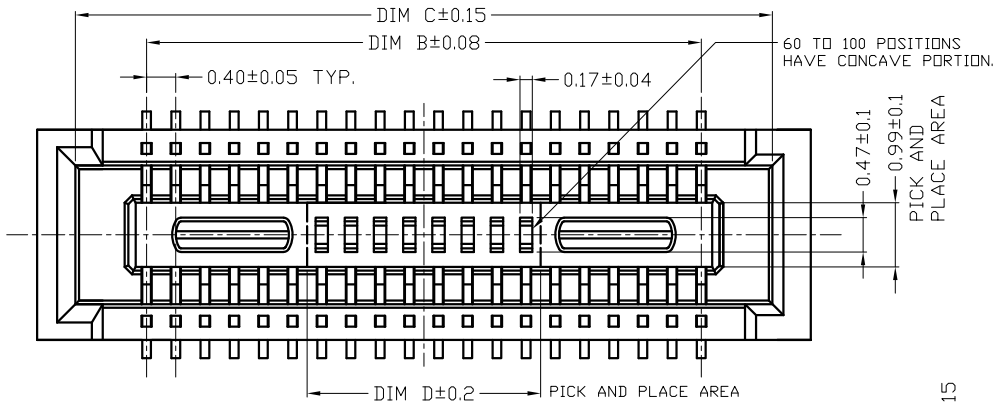
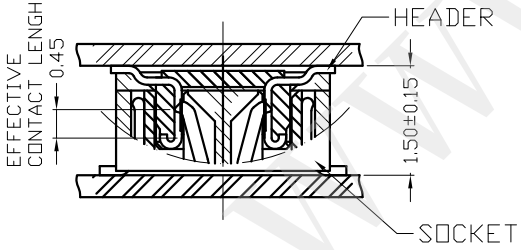
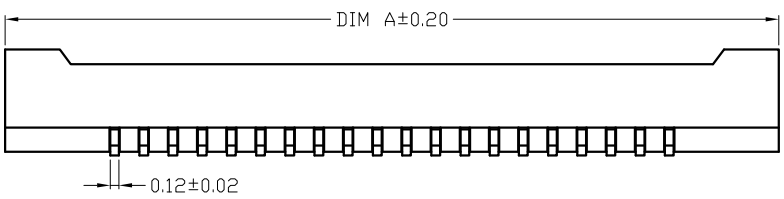
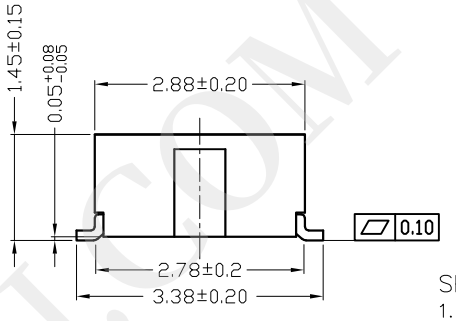
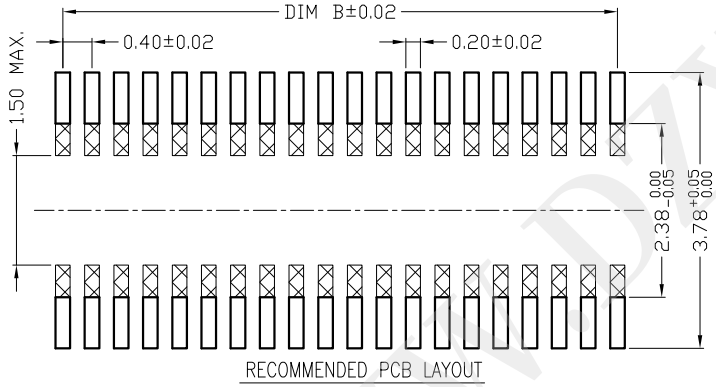




PIN NO.	DIM A	DIM B	DIM C	DIM D
10	4.60	1.60	3.55	1.00
20	6.60	3.60	5.55	1.00
24	7.40	4.40	6.35	1.20
30	8.60	5.60	7.55	1.50
34	9.40	6.40	8.35	1.50
40	10.60	7.60	9.55	3.20
50	12.60	9.60	11.55	3.20
60	14.60	11.60	13.55	3.20
70	16.60	13.60	15.55	3.20
80	18.60	15.60	17.55	3.20
90	20.60	17.60	19.55	3.20
100	22.60	19.60	21.55	3.20
120	26.60	23.60	25.55	3.20







SPECIFICATIONS:
1.VOLTAGE/CURRENT RATING: 30V/AC, DC,0.3A;
2.WITHSTANDING VOLTAGE: 100V AC/ONE MINUTE;
3.INSULATION RESISTANCE: 50MΩ MIN/100V DC.;
4.CONTACT RESISTANCE: 90mΩ MAX./1mA,20mV AC,1KHz;
5.DURABILITY: 30 CYCLES;
6.OPERATING TEMPERATURE RANGE: −35° C TO 85° C.
MATERIAL:
1.INSULATOR: LCP UL 94V−0 BLACK;
2.TERMINAL: PHOSPHOR BRONZE;
PLATING:
1.TERMINAL: CONTACT AREA: GOLD 0.05μm"MIN.
SMT LEAD: GOLD 0.025μm" MIN.
UNDERPLATING: NICKEL 1μm" MIN.

深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30, X.XX ±0.25, X.XXX ±0.15, X.° ±2°, X.X° ±0.5°	DRAWED BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 0.4PH 单槽BTB 母(合高1.5H)
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYC20F-BTB2XN-145
UNIT: mm [inch]			MOLD NO.
	APPROVED BY: 邱敏	DATE : 2014-02-23	DRAW NO: HYC-2401251702
SCALE:1:1 SIZE: A4			SHEET NO. 1 OF 1

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